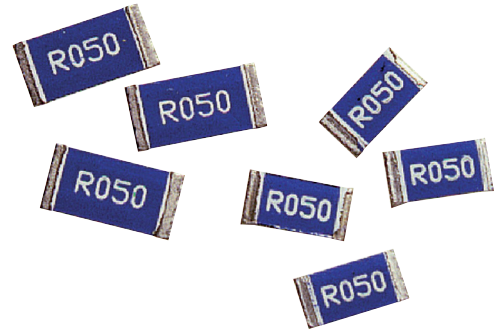


Low Value Flat Chip Resistor

LR Series

- Standard 2512, 2010 and 1206 sizes
- Resistance values down to 0.003 ohms
- Leach resistant solder-plated copper wrap-around termination
- AEC-Q200 Qualified
- RoHS compliant and SnPb variants



All Pb-free parts comply with EU Directive 2011/65/EU amended by (EU) 2015/863 (RoHS3)

Electrical Data

		LR(F)1206	LR(F)2010	LR(F)2512
Power rating @70°C	watts	0.5	1	2
Resistance range ¹	ohms	R003 to 1R0		
Resistance tolerance ¹	%	<R01: 5, ≥R01: 1, 2, 5		
TCR	ppm/°C	≥R05: ±100, R025–R047: <+200, R015–R024: <+300, R01–R014: <+500, <R01: <+900		
Dielectric withstand	volts	200		
Ambient temperature range	°C	-55 to +150		
Values		E24 preferred ²		
Temperature rise at rated power	°C	40	80	90
Pad / trace area ³	mm ²	30	100	300

Note 1: Contact factory for value – tolerance combinations outside this range. Note 2: Many values = N x R001 and N x R005 up to N=10 are also available. Note 3: Recommended minimum pad & adjacent trace area for each termination for rated dissipation on FR4 PCB

Physical Data

Dimensions (mm)				
Size	L	W	H (max)	D
LR(F)1206	3.20±0.305	1.63±0.20	0.8	0.6 ±0.25
LR(F)2010	5.23±0.38	2.64±0.25	0.84	0.6 ±0.25
LR(F)2512	6.50±0.38	3.25±0.25	0.84	0.6 ±0.25

Recommended Solder Pad Dimensions (mm)			
	A	B	C
LR(F)1206	2.0	4.0	1.25
LR(F)2010	3.05	6.5	1.5
LR(F)2512	3.7	7.75	1.5

Marking

LR parts are marked with the value code, where this is up to four characters (e.g. "R025"). For five character value codes the value in milliohms is marked, with "m" indicating decimal position (e.g. "2m5" for value code R0025).

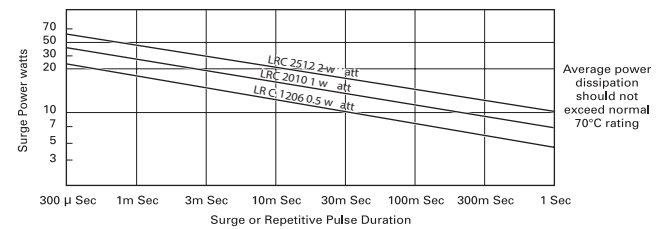
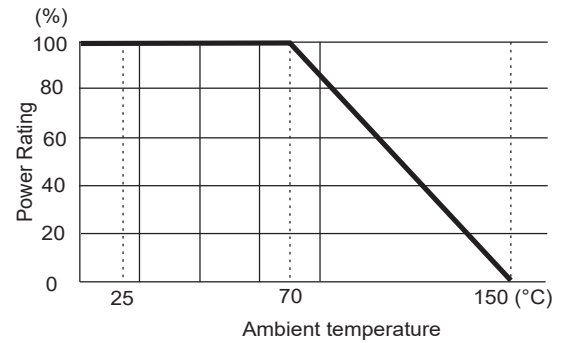
General Note

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LR Series

Performance Data

AEC-Q200 Table 7		Method	Max.		Typ.
ref	Test		(add R05)		
3	High Temp. Exposure	MIL-STD-202 Method 108	ΔR%	0.5	0.2
4	Temperature Cycling	JESD22 Method JA-104	ΔR%	0.25	0.1
6	Moisture Resistance	MIL-STD-202 Method 106	ΔR%	0.5	0.2
7	Biased Humidity	MIL-STD-202 Method 103	ΔR%	0.5	0.2
8	Operational Life (Cyclic Load)	MIL-STD-202 Method 108	ΔR%	1	0.5
14	Vibration	MIL-STD-202 Method 204	ΔR%	0.5	0.05
15	Resistance to Soldering Heat	MIL-STD-202 Method 210	ΔR%	0.25	0.05
16	Thermal Shock	MIL-STD-202 Method 107	ΔR%	0.25	0.1
18	Solderability	J-STD-002	>95% coverage		
21	Board Flex	AEC-Q200-005	ΔR%	0.5	0.2
22	Terminal Strength	AEC-Q200-006	ΔR%	0.25	0.1
Short Term Overload		6.25 x Pr for 2s	ΔR%	0.5	
Low Temperature Storage		-65°C for 100 hours	ΔR%	0.5	
Leach Resistance		Solder dip at 250°C	90s minimum		



Note:

1. Although 2010 and 2512 sizes have passed temperature cycling and thermal shock, it is in general not recommended that ceramic chips this large be used on FR4 in a severe temperature cycle environment due to the possibility of solder joint fatigue. Full AEC-Q200 qualification applies only to ohmic values $\geq R01$.

Ordering Procedure

This product has two valid part numbers:

European (Welwyn) Part Number: LRF1206-R02FW (1206, 20 milliohms $\pm 1\%$, Pb-free)

L	R	F	1	2	0	6	-	R	0	2	F	W
1		2		3		4		5				

1	2	3	4	5
Type	Size	Value	Tolerance	Termination & Packing
LR = Conventional orientation (values $>R025$)	1206 2010	E24 = 3/4 characters R = ohms	F = $\pm 1\%$ G = $\pm 2\%$ J = $\pm 5\%$	W Pb-free, standard packing T1 Pb-free, 1000/reel (non-standard)
LRF = Flip-chip orientation (values $\leq R025$)	2512			PB SnPb finish, standard packing T1PB SnPb finish, 1000/reel (non-standard)
Standard packing is tape & reel				
1206 & 2010		3000/reel		
2512		1800/reel		

USA (IRC) Part Number: LRC-LRF1206LF-01-R020-F (1206, 20 milliohms $\pm 1\%$, Pb-free)

L	R	C	-	L	R	F	1	2	0	6	L	F	-	0	1	-	R	0	2	0	-	F
1		2		3		4		5		6		7										

1	2	3	4	5	6	7	Packing		
Family	Model	Size	Termination	TCR	Value	Tolerance			
LRC	LR = Conventional orientation (values $>R025$)	1206 2010	Omit for SnPb LF = Pb-free	01 = standard ($\pm 100\text{ppm}/^\circ\text{C}$ values $\geq R05$)	4 characters R = ohms	F = $\pm 1\%$ G = $\pm 2\%$ J = $\pm 5\%$	Standard packing is tape & reel		
	LRF = Flip-chip orientation (values $\leq R025$)	2512					Pb-free	All sizes	1000/reel
							SnPb	1206 & 2010	3000/reel
								2512	1800/reel

General Note

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